

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Rabindra N. Das	07/14/2010
Roy H. Magnuson	07/14/2010
Mark D. Poliks	07/14/2010
Voya R. Markovich	07/14/2010

RECEIVING PARTY DATA

Name:	Endicott Interconnect Technologies, Inc.
Street Address:	1093 Clark Street
City:	Endicott
State/Country:	NEW YORK
Postal Code:	13760

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12884657

CORRESPONDENCE DATA

Fax Number: (607)723-6605
Correspondence will be sent via US Mail when the fax attempt is unsuccessful.
 Phone: 6072316991
 Email: amanzner@hkh.com
 Correspondent Name: Mark Levy, HINMAN, HOWARD & KATTELL, LLP
 Address Line 1: 80 Exchange Street
 Address Line 4: Binghamton, NEW YORK 13901

ATTORNEY DOCKET NUMBER:	EI-2-08-023
NAME OF SUBMITTER:	Mark Levy

Total Attachments: 2
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CH \$40.00 12884657

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**PATENT
 REEL: 025005 FRAME: 0403**

**Assignment of Rights, Title and Interest in Invention
(Multiple inventors; single assignee)**

Docket No.
E1-2-08-023

This is an Assignment of the following rights, title and interest: (check all that apply):

- United States of America rights, title and interest in the invention*
- Foreign rights, title and interest in the invention*
- United States Patent Application Serial No. _____*
Date of Execution: _____ Date of Filing: _____
- United States Provisional Patent Application Serial No. _____*
- United States Patent No(s). _____*
- International (PCT) Patent Application Serial No. _____*
- Other (specify) _____*

Title of the Invention

CONDUCTING PASTE FOR DEVICE LEVEL INTERCONNECTS

Inventors (assignors)

<i>Name</i>	<i>Address</i>
Rabindra N. Das	3113 Belmont Avenue, Vestal, NY 13850
Roy H. Magnuson	804 Audrey Court, Endicott, NY 13760
Mark D. Poliks	1724 Terrace Drive, Vestal, NY 13850
Voya R. Markovich	3611 Joel Drive, Endwell, NY 13760

Assignee

<i>Name</i>	<i>Address</i>
Endicott Interconnect Technologies, Inc.	1093 Clark Street Endicott, NY 13760

Assignment of Rights, Title and Interest in Invention
(Multiple inventors; single assignee)

Docket No.
EI-2-08-023

Whereas, we, the above-identified Inventors, have invented certain new and useful improvements in the Invention identified above and described in the above-identified patent application(s) and/or patent(s) (hereinafter referred to as "Invention");

And, whereas we desire to assign our above-identified rights, title and interest in the Invention to the above-identified Assignee;

Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

We hereby assign, sell and transfer our above-identified rights, title and interest in said Invention, said application(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted or have granted for said Invention, and in and to any and all reissues and reexaminations thereof, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, unto said Assignee;

And we hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Letters Patent which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto;

And we further agree to sign and execute all necessary and lawful future documents, including applications for foreign patents, for filing divisions, continuations and continuations-in-part of said application for patent, and/or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignee or its Designee(s) may from time to time require and prepare at its own expense.

Inventors' Signatures (if Notarization is desired, do not sign here and proceed to next page)

Name	Signature/Date
Rabindra N. Das	Rabindra N. Das 7/14/2010
Roy H. Magnuson	Roy H. Magnuson 7/14/10
Mark D. Poliks	Mark D. Poliks 7/14/10
Voya R. Markovich	Voya R. Markovich 7/14/10